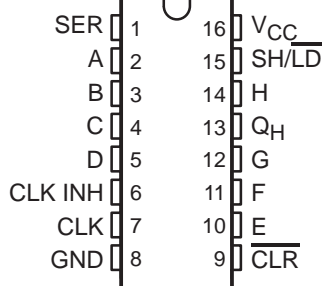


# SN54HC166, SN74HC166 8-BIT PARALLEL-LOAD SHIFT REGISTERS

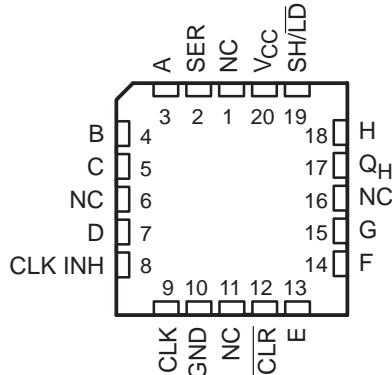
SCLS117D – DECEMBER 1982 – REVISED SEPTEMBER 2003

- Wide Operating Voltage Range of 2 V to 6 V
- Outputs Can Drive Up To 10 LSTTL Loads
- Low Power Consumption, 80- $\mu$ A Max  $I_{CC}$
- Typical  $t_{pd} = 13$  ns
- $\pm 4$ -mA Output Drive at 5 V
- Low Input Current of 1  $\mu$ A Max
- Synchronous Load
- Direct Overriding Clear
- Parallel-to-Serial Conversion

SN54HC166 . . . J OR W PACKAGE  
SN74HC166 . . . D, DB, N, NS, OR PW PACKAGE  
(TOP VIEW)



SN54HC166 . . . FK PACKAGE  
(TOP VIEW)



NC – No internal connection

## description/ordering information

### ORDERING INFORMATION

TA	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	PDIP – N	Tube of 25	SN74HC166N	SN74HC166N
	SOIC – D	Tube of 40	SN74HC166D	HC166
		Reel of 2500	SN74HC166DR	
		Reel of 250	SN74HC166DT	
	SOP – NS	Reel of 2000	SN74HC166NSR	HC166
	SSOP – DB	Reel of 2000	SN74HC166DBR	HC166
-55°C to 125°C	TSSOP – PW	Tube of 90	SN74HC166PW	HC166
		Reel of 2000	SN74HC166PWR	
		Reel of 250	SN74HC166PWT	
-55°C to 125°C	CDIP – J	Tube of 25	SNJ54HC166J	SNJ54HC166J
	CFP – W	Tube of 150	SNJ54HC166W	SNJ54HC166W
	LCCC – FK	Tube of 55	SNJ54HC166FK	SNJ54HC166FK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS  
INSTRUMENTS**

POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 2003, Texas Instruments Incorporated  
On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

# SN54HC166, SN74HC166

## 8-BIT PARALLEL-LOAD SHIFT REGISTERS

SCLS117D – DECEMBER 1982 – REVISED SEPTEMBER 2003

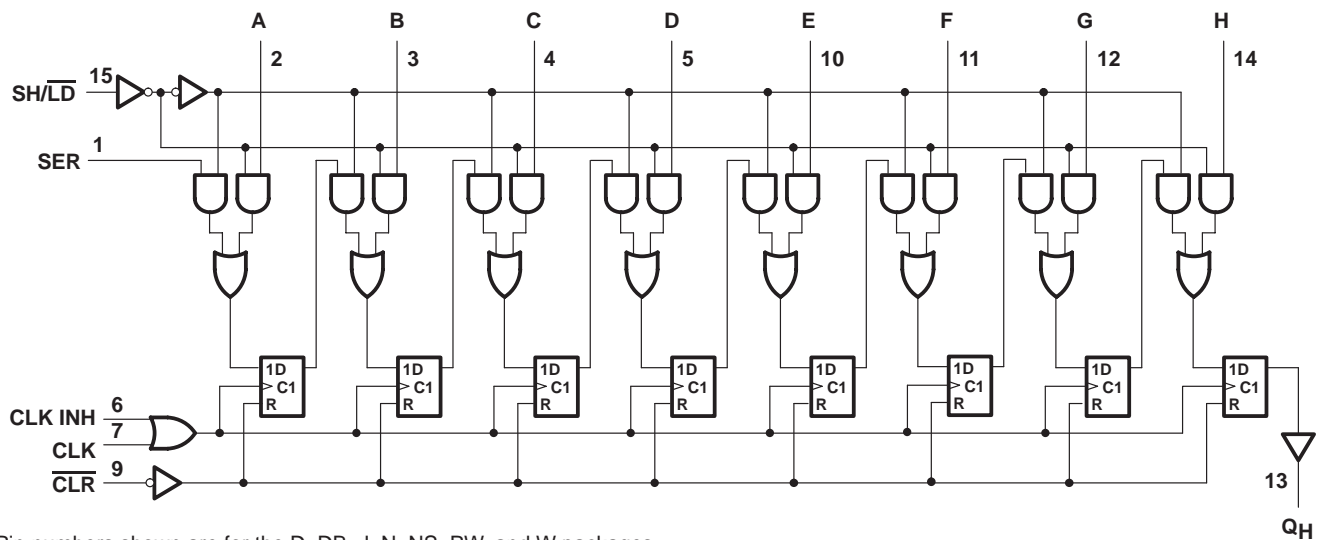
### description/ordering information (continued)

These parallel-in or serial-in, serial-out registers feature gated clock (CLK, CLK INH) inputs and an overriding clear ( $\overline{\text{CLR}}$ ) input. The parallel-in or serial-in modes are established by the shift/load ( $\text{SH}/\overline{\text{LD}}$ ) input. When high,  $\text{SH}/\overline{\text{LD}}$  enables the serial (SER) data input and couples the eight flip-flops for serial shifting with each clock (CLK) pulse. When low, the parallel (broadside) data inputs are enabled, and synchronous loading occurs on the next clock pulse. During parallel loading, serial data flow is inhibited. Clocking is accomplished on the low-to-high-level edge of CLK through a 2-input positive-NOR gate, permitting one input to be used as a clock-enable or clock-inhibit function. Holding either CLK or CLK INH high inhibits clocking; holding either low enables the other clock input. This allows the system clock to be free running, and the register can be stopped on command with the other clock input.  $\overline{\text{CLR}}$  overrides all other inputs, including CLK, and resets all flip-flops to zero.

FUNCTION TABLE

INPUTS						OUTPUTS		
						INTERNAL		$Q_H$
$\overline{\text{CLR}}$	$\text{SH}/\overline{\text{LD}}$	CLK INH	CLK	SER	PARALLEL A . . . H	$Q_A$	$Q_B$	
L	X	X	X	X	X	L	L	L
H	X	L	L	X	X	$Q_{A0}$	$Q_{B0}$	$Q_{H0}$
H	L	L	$\uparrow$	X	a . . . h	a	b	h
H	H	L	$\uparrow$	H	X	H	$Q_{An}$	$Q_{Gn}$
H	H	L	$\uparrow$	L	X	L	$Q_{An}$	$Q_{Gn}$
H	X	H	$\uparrow$	X	X	$Q_{A0}$	$Q_{B0}$	$Q_{H0}$

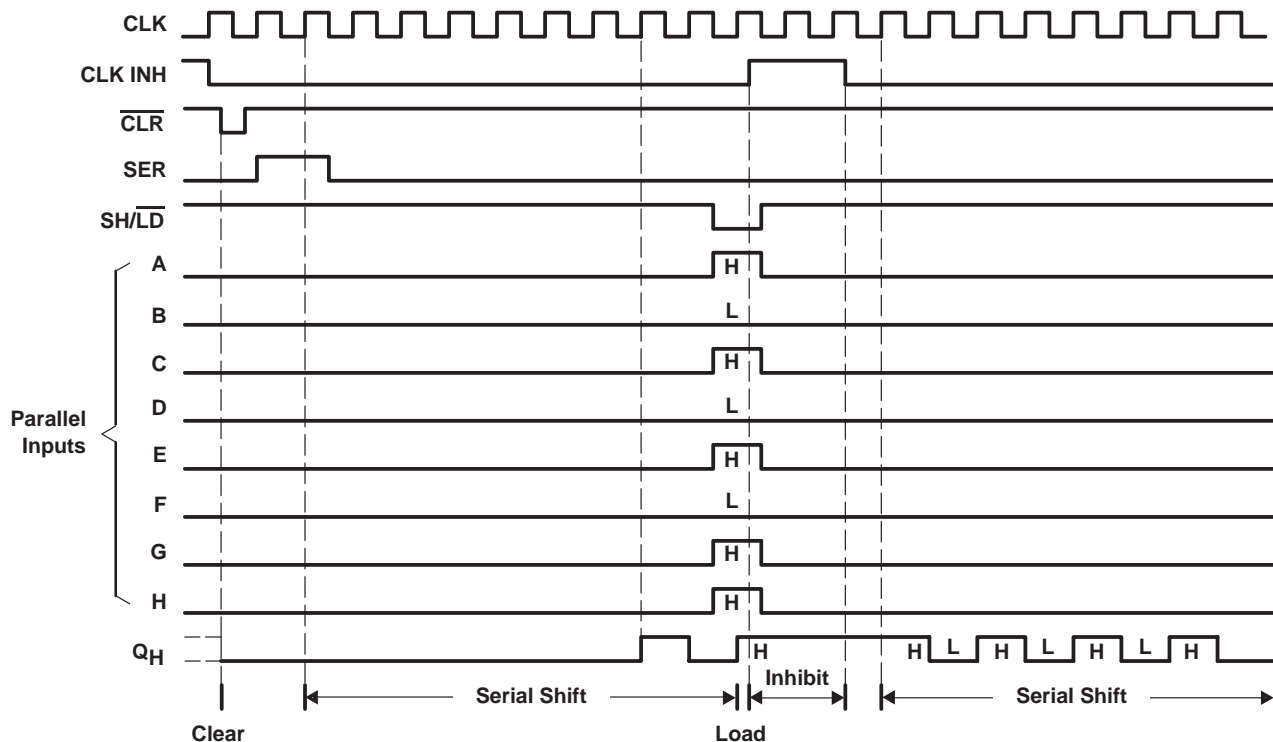
### logic diagram (positive logic)



# SN54HC166, SN74HC166 8-BIT PARALLEL-LOAD SHIFT REGISTERS

SCLS117D – DECEMBER 1982 – REVISED SEPTEMBER 2003

## typical clear, shift, load, inhibit, and shift sequence



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, $V_{CC}$ .....	-0.5 V to 7 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) (see Note 1) .....	$\pm 20$ mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) (see Note 1) .....	$\pm 20$ mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ ) .....	$\pm 25$ mA
Continuous current through $V_{CC}$ or GND .....	$\pm 50$ mA
Package thermal impedance, $\theta_{JA}$ (see Note 2): D package .....	73°C/W
DB package .....	82°C/W
N package .....	67°C/W
NS package .....	64°C/W
PW package .....	108°C/W
Storage temperature range, $T_{stg}$ .....	-65°C to 150°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
2. The package thermal impedance is calculated in accordance with JESD 51-7.

# SN54HC166, SN74HC166

## 8-BIT PARALLEL-LOAD SHIFT REGISTERS

SCLS117D – DECEMBER 1982 – REVISED SEPTEMBER 2003

### recommended operating conditions (see Note 3)

		SN54HC166			SN74HC166			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
$V_{CC}$	Supply voltage	2	5	6	2	5	6	V
$V_{IH}$	High-level input voltage	$V_{CC} = 2\text{ V}$		1.5	1.5		V	
		$V_{CC} = 4.5\text{ V}$		3.15	3.15			
		$V_{CC} = 6\text{ V}$		4.2	4.2			
$V_{IL}$	Low-level input voltage	$V_{CC} = 2\text{ V}$		0.5		0.5	V	
		$V_{CC} = 4.5\text{ V}$		1.35		1.35		
		$V_{CC} = 6\text{ V}$		1.8		1.8		
$V_I$	Input voltage	0	$V_{CC}$		0	$V_{CC}$		V
$V_O$	Output voltage	0	$V_{CC}$		0	$V_{CC}$		V
$\Delta t/\Delta v^\dagger$	Input transition rise/fall time	$V_{CC} = 2\text{ V}$		1000		1000		ns
		$V_{CC} = 4.5\text{ V}$		500		500		
		$V_{CC} = 6\text{ V}$		400		400		
$T_A$	Operating free-air temperature	-55	125		-40	85		°C

NOTE 3: All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

† If this device is used in the threshold region (from  $V_{IL\text{max}} = 0.5\text{ V}$  to  $V_{IH\text{min}} = 1.5\text{ V}$ ), there is a potential to go into the wrong state from induced grounding, causing double clocking. Operating with the inputs at  $t_f = 1000\text{ ns}$  and  $V_{CC} = 2\text{ V}$  does not damage the device; however, functionally, the CLK inputs are not ensured while in the shift, count, or toggle operating modes.

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		$V_{CC}$	$T_A = 25^\circ\text{C}$			SN54HC166		SN74HC166		UNIT	
				MIN	TYP	MAX	MIN	MAX	MIN	MAX		
$V_{OH}$	$V_I = V_{IH}$ or $V_{IL}$	$I_{OH} = -20\ \mu\text{A}$	2 V	1.9	1.998		1.9		1.9	V		
			4.5 V	4.4	4.499		4.4		4.4			
			6 V	5.9	5.999		5.9		5.9			
		$I_{OH} = -4\text{ mA}$	4.5 V	3.98	4.3		3.7		3.84			
			6 V	5.48	5.8		5.2		5.34			
$V_{OL}$	$V_I = V_{IH}$ or $V_{IL}$	$I_{OL} = 20\ \mu\text{A}$	2 V		0.002	0.1		0.1		V		
			4.5 V		0.001	0.1		0.1				
			6 V		0.001	0.1		0.1				
		$I_{OL} = 4\text{ mA}$	4.5 V		0.17	0.26		0.4			0.33	
			6 V		0.15	0.26		0.4			0.33	
$I_I$	$V_I = V_{CC}$ or 0		6 V		$\pm 0.1$	$\pm 100$		$\pm 1000$		$\pm 1000$	nA	
$I_{CC}$	$V_I = V_{CC}$ or 0, $I_O = 0$		6 V				8		160		80	$\mu\text{A}$
$C_i$			2 V to 6 V		3	10		10			10	pF



# SN54HC166, SN74HC166 8-BIT PARALLEL-LOAD SHIFT REGISTERS

SCLS117D – DECEMBER 1982 – REVISED SEPTEMBER 2003

timing requirements over recommended operating free-air temperature range (unless otherwise noted)

		V <sub>CC</sub>	T <sub>A</sub> = 25°C		SN54HC166		SN74HC166		UNIT		
			MIN	MAX	MIN	MAX	MIN	MAX			
f <sub>clock</sub>	Clock frequency	2 V	6		4.2		5		MHz		
		4.5 V	31		21		25				
		6 V	36		25		29				
t <sub>w</sub>	$\overline{\text{CLR}}$ low	2 V	100		150		125		ns		
		4.5 V	20		30		25				
		6 V	17		26		21				
	CLK high or low	2 V	80		120		100				
		4.5 V	16		24		20				
		6 V	14		20		17				
t <sub>su</sub>	SH/ $\overline{\text{LD}}$ high before CLK↑	2 V	145		220		180		ns		
		4.5 V	29		44		36				
		6 V	25		38		31				
	SER before CLK↑	2 V	80		120		100				
		4.5 V	16		24		20				
		6 V	14		20		17				
	CLK INH low before CLK↑	2 V	100		150		125				
		4.5 V	20		30		25				
		6 V	17		26		21				
	Data before CLK↑	2 V	80		120		100				
		4.5 V	16		24		20				
		6 V	14		20		17				
	$\overline{\text{CLR}}$ inactive before CLK↑	2 V	40		60		50				
		4.5 V	8		12		10				
		6 V	7		10		9				
	t <sub>h</sub>	SH/ $\overline{\text{LD}}$ high after CLK↑	2 V	0		0		0			ns
			4.5 V	0		0		0			
			6 V	0		0		0			
SER after CLK↑		2 V	5		5		5				
		4.5 V	5		5		5				
		6 V	5		5		5				
CLK INH high after CLK↑		2 V	0		0		0				
		4.5 V	0		0		0				
		6 V	0		0		0				
Data after CLK↑		2 V	5		5		5				
		4.5 V	5		5		5				
		6 V	5		5		5				



# SN54HC166, SN74HC166

## 8-BIT PARALLEL-LOAD SHIFT REGISTERS

SCLS117D – DECEMBER 1982 – REVISED SEPTEMBER 2003

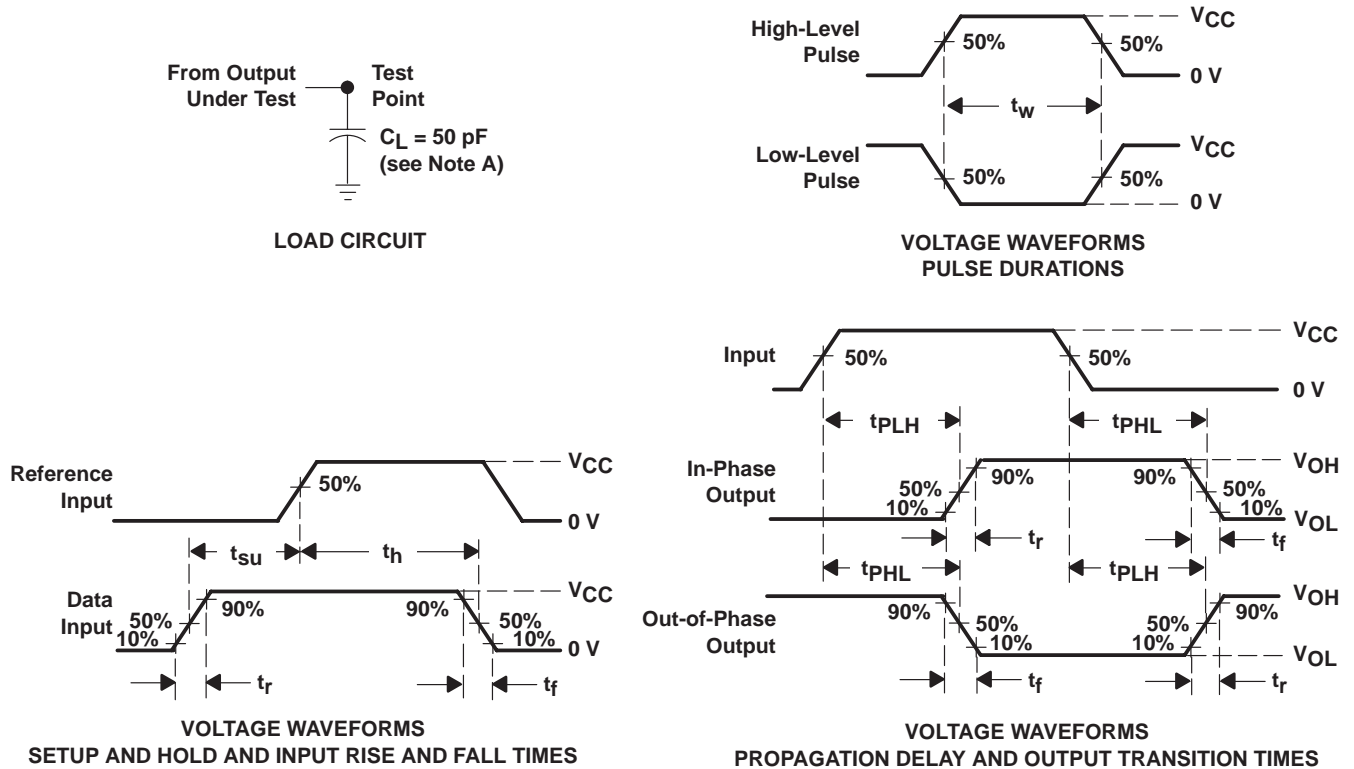
switching characteristics over recommended operating free-air temperature range,  $C_L = 50 \text{ pF}$  (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC}$	$T_A = 25^\circ\text{C}$			SN54HC166		SN74HC166		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$f_{\text{max}}$			2 V	6	11		4.2		5	MHz	
			4.5 V	31	36		21		25		
			6 V	36	45		25		29		
$t_{\text{PHL}}$	$\overline{\text{CLR}}$	$Q_H$	2 V		62	120		180		150	ns
			4.5 V		18	24		36		30	
			6 V		13	20		31		26	
$t_{\text{pd}}$	CLK	$Q_H$	2 V		75	150		225		190	ns
			4.5 V		15	30		45		38	
			6 V		13	26		38		32	
$t_t$		Any	2 V		38	75		110		95	ns
			4.5 V		8	15		22		19	
			6 V		6	13		19		16	

operating characteristics,  $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	TYP	UNIT
$C_{\text{pd}}$	Power dissipation capacitance	No load	50	pF

PARAMETER MEASUREMENT INFORMATION



- NOTES: A.  $C_L$  includes probe and test-fixture capacitance.  
 B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r = 6 \text{ ns}$ ,  $t_f = 6 \text{ ns}$ .  
 C. For clock inputs,  $f_{max}$  is measured when the input duty cycle is 50%.  
 D. The outputs are measured one at a time with one input transition per measurement.  
 E.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Figure 1. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
5962-9050101Q2A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
5962-9050101QEA	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
SN54HC166J	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
SN74HC166D	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74HC166DBR	ACTIVE	SSOP	DB	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74HC166DR	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74HC166DT	ACTIVE	SOIC	D	16	250	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74HC166N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74HC166NSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74HC166PW	ACTIVE	TSSOP	PW	16	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
SN74HC166PWR	ACTIVE	TSSOP	PW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
SN74HC166PWT	ACTIVE	TSSOP	PW	16	250	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
SNJ54HC166FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54HC166J	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - May not be currently available - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**None:** Not yet available Lead (Pb-Free).

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

J (R-GDIP-T\*\*)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



4040083/F 03/03

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package is hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

FK (S-CQCC-N\*\*)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



4040140/D 10/96

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a metal lid.
  - D. The terminals are gold plated.
  - E. Falls within JEDEC MS-004

N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - D. Falls within JEDEC MS-012 variation AC.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



PW (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

<b>Products</b>		<b>Applications</b>	
Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>	Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>	Automotive	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>	Broadband	<a href="http://www.ti.com/broadband">www.ti.com/broadband</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>	Digital Control	<a href="http://www.ti.com/digitalcontrol">www.ti.com/digitalcontrol</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>	Military	<a href="http://www.ti.com/military">www.ti.com/military</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>	Optical Networking	<a href="http://www.ti.com/opticalnetwork">www.ti.com/opticalnetwork</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>	Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
		Telephony	<a href="http://www.ti.com/telephony">www.ti.com/telephony</a>
		Video & Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>
		Wireless	<a href="http://www.ti.com/wireless">www.ti.com/wireless</a>

Mailing Address: Texas Instruments  
Post Office Box 655303 Dallas, Texas 75265